

RoHS Compliance Material Declaration Report

Company:	Pericom
Name:	Nang Su
Title:	Quality Engineer
e-mail:	nsu@pericom.com

Address:	3545 North First Street, San Jose, CA, 95134
Phone number:	(408) 435 0800
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Part Detail				
Pericom Part Number	Manufacturer part description	Package Type	Number of Pin/Terminal	Component overall weight
PI90LV387AE	16 LVDS Receivers	TSSOP (6.1mm width)	64	0.263851

RoHS Compliance		
Is Part compliant to EU RoHS Directive? [1] Yes, [2] Yes with tech exemption* [3] Yes but needs product application exemption* [4] No	RoHS tech exemption [2] details.	Date Component was RoHS Compliant.
Yes	N/A	Since Inception

Content of RoHS restricted materials (g)						
Lead	Cadmium	Mercury	Hexavalent Chromium	Polybrominated biphenyls (PBB)	Polybrominated Diphenylethers (PBDE)	RoHS restricted substance added intentionally? For what reason?
0	0	0	0	0	0	N/A

Component Soldering Process						
Interconnect Composition, (Metallurgy of the lead/terminal)	JEDEC JEDS97 Pb-free Category	Compatible with a 260C 10s Pb-Free assembly process	Backward compatible with SnPb assembly	Maximum Processing Temperature (°C)	Max Temperature Duration	Max Number of reflow cycles
Sn	e3	Yes	Yes	260	40	3

Plastics (if applicable)			
Oxygen Index	Type of plastic material used in the component	Fire: UL Rating	MSL Level (per JEDEC STD 020C)
>28%	Epoxy Resin	V-0	1

Tin (Sn) Plating (If Applicable)						
Tin (Sn) Plating – is it Matte (M) or Bright (B)?	Tin (Sn) Plating Thickness	Tin (Sn) plating is there a Nickel (Ni) Barrier? - Yes / No	Nickel Barrier Thickness	If no Nickel barrier is the tin (Sn) termination finish heat treated?	Performed Tin Whisker Test ?	
М	7 to 20 um	No	N/A	Yes, 150C / 1 Hr	Yes	

Bismuth (Bi)		
Bismuth (Bi) Content (if applicable)		
	0	

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